

Additive Manufacturing and Functional Materials Symposium

Thursday and Friday, June 22-23, 2017
University of Washington, Seattle



Contact: AJ Boydston (ajb1515@uw.edu)
Registration: \$50 (\$25 for students)
More to come soon...<http://blogs.uw.edu/am2i/>

This 2-day symposium will bring together an international audience to discuss the cutting edge of additive manufacturing (AM) technologies. The symposium will focus on the interface between AM and functional polymeric materials, and will feature invited speakers and contributed posters.

Confirmed speakers include: Annalisa Chioppone (Istituto Italiano di Tecnologia), Michael Dickey (NC State), Igor Drstvenšek (University of Maribor), Howon Lee (Rutgers), Michael McAlpine (UMN), Alshakim Nelson (UW-Seattle), Eujin Pei (Brunel University London), Kristina Shea (ETH Zurich), Scott Phillips (Penn State University)